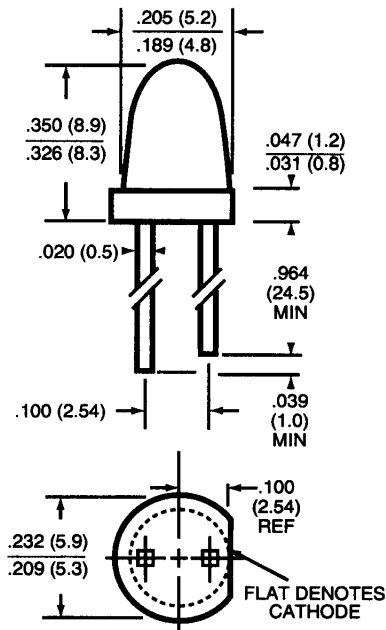


SUPER BLUE

MV8B11

MV8B12

PACKAGE DIMENSIONS



DESCRIPTION

These T-1 3/4 super-bright blue LEDs have a narrow viewing angle of 10° for concentrated light output. The blue diode chip is constructed with GaN/SiC technology and emits a peak wavelength of 430 nm.

FEATURES

- Popular T-1 3/4 package
- Low drive current
- Solid state reliability
- Super high brightness
- Water clear optics
- Standard 100 mil. lead spacing

- Note: 1) All dimensions are in inches (mm).
 2) Lead spacing is measured where the leads emerge from the package.
 3) Protruded resin under the flange is 1.5mm (0.059") max.

ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise specified)

DC Forward Current (I _F)	30 mA
Peak Forward Current (I _F) @ f = 1.0 KHz, Duty factor = 1/10	100 mA
Power Dissipation (P _d)	115 mW
Reversed Voltage (V _R) I _R = 10 μA	5
Operating Temperature Range	-40°C to +100°C
Storage Temperature Range	-40°C to +100°C
Lead Soldering Time	5 secs @ 260°C for wave solder; 10 secs @ 260°C for IR reflow

ELECTRO-OPTICAL CHARACTERISTICS (T_A=25°C unless otherwise specified)

Part Number:		<u>MV8B11</u>	<u>MV8B12</u>	<u>Test Condition</u>
Luminous Intensity (mcd)	Minimum	400	630	I _F = 20 mA
	Typical	600	940	
Forward Voltage (V _F)	Typical	3.8	3.8	I _F = 20 mA
	Maximum	4.5	4.5	
Peak Wavelength (nm)		430	430	I _F = 20 mA
Spectral Line Half Width (nm)		65	65	I _F = 20 mA
Viewing Angle (degrees)		10	10	I _F = 20 mA

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES (T_A = 25°C)

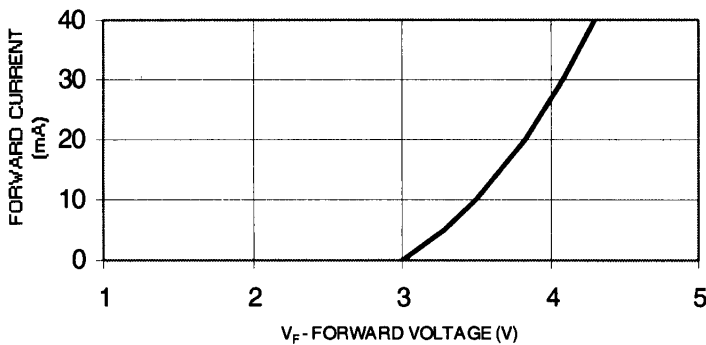


Fig 1. Forward Current vs. Forward Voltage

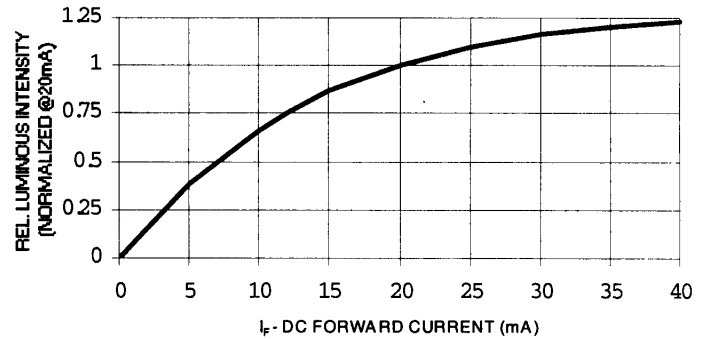


Fig 2. Rel. Luminous Intensity vs. DC Forward Current

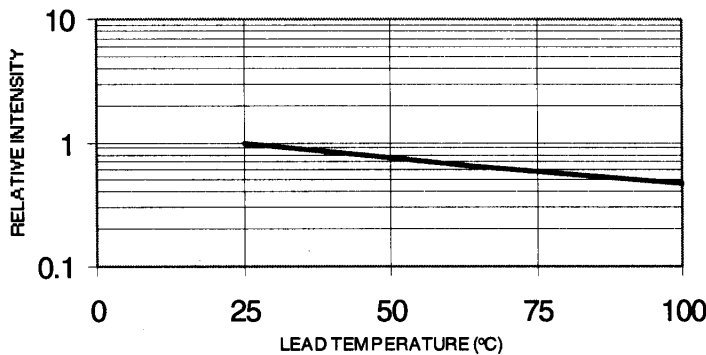


Fig 3. Rel. Intensity vs. Lead Temperature
(Pulsed 20 mA; 300 us pulse, 10 ms period)

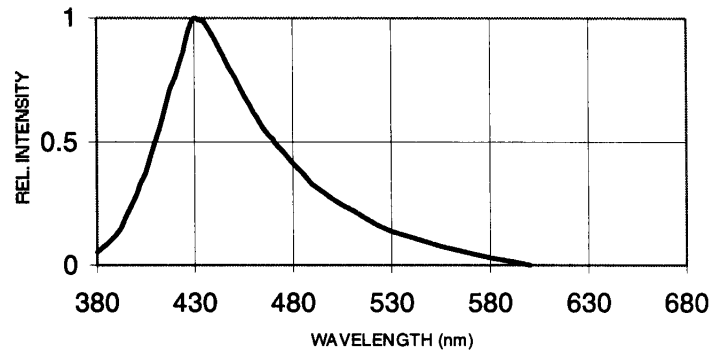


Fig 4. Rel. Intensity vs. Wavelength

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES (T_A = 25°C)

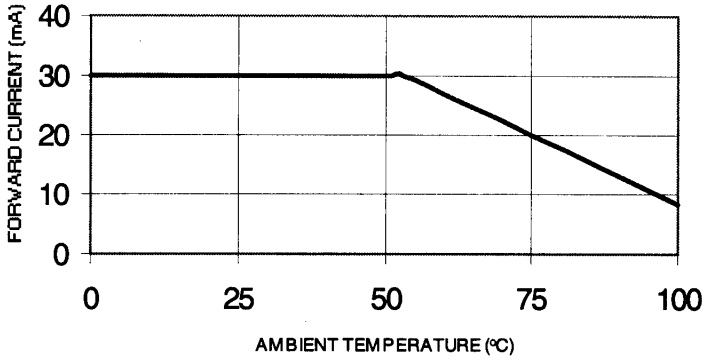


Fig 5. Forward Current vs. Ambient Temperature

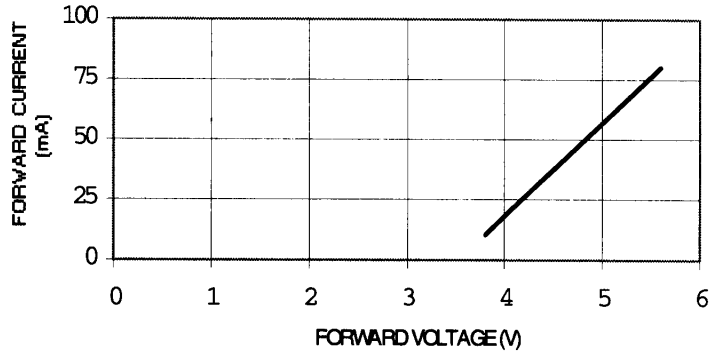


Fig. 6 Peak Forward Voltage vs. Forward Current
(100 us test pulse, 1% duty cycle)

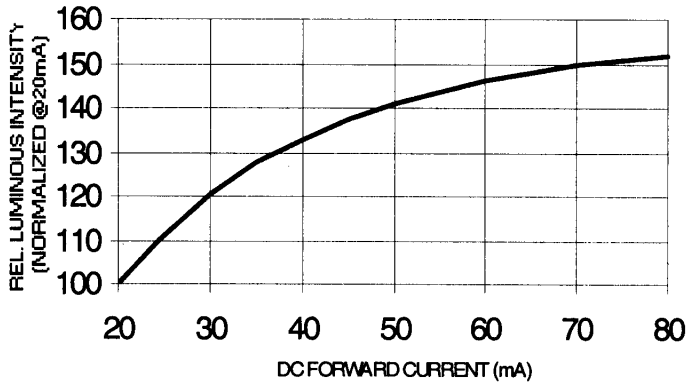


Fig. 7 Rel. Luminous Intensity vs. Peak Forward Current
(300 us pulse width; 10 ms period)

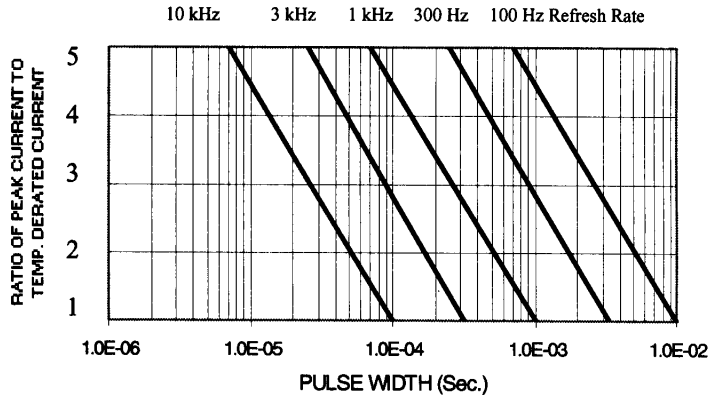


Fig. 8 Pulse Derating Curve

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